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ROUND TYPE LED LAMPS



Lead-Free Parts

LWK2043Z/F139

DATA SHEET

DOC. NO : QW0905-LWK2043Z/F139

REV. : A

DATE : 07 - Jul. - 2009





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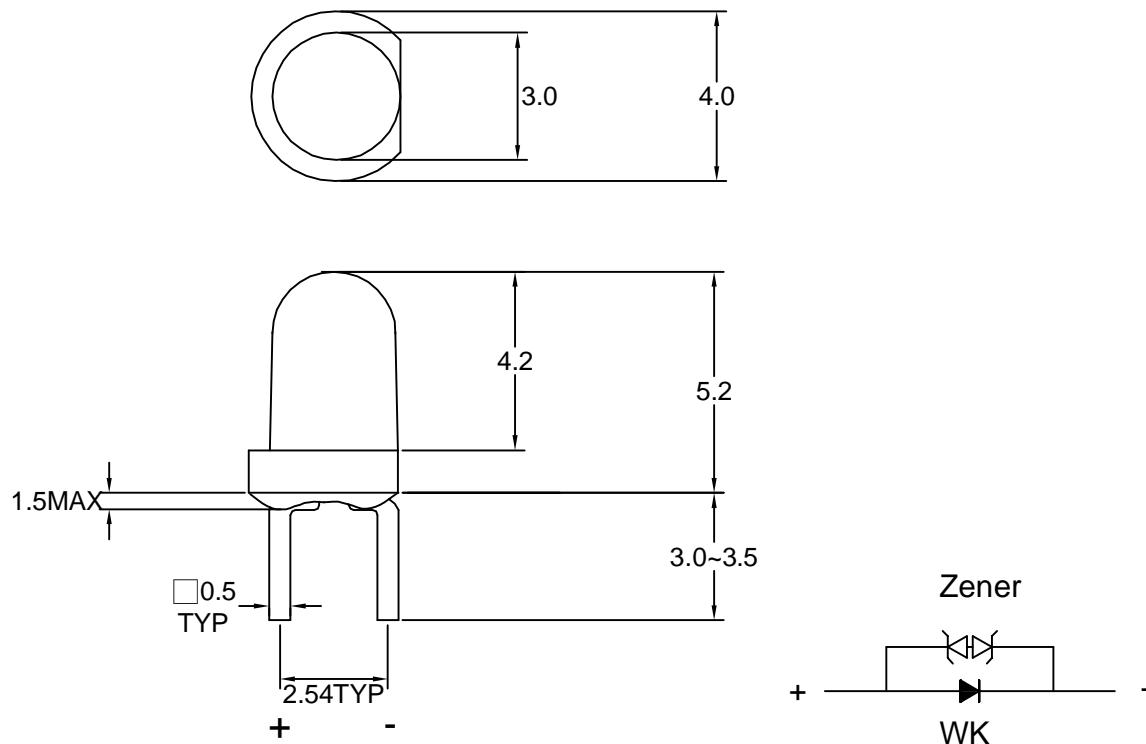
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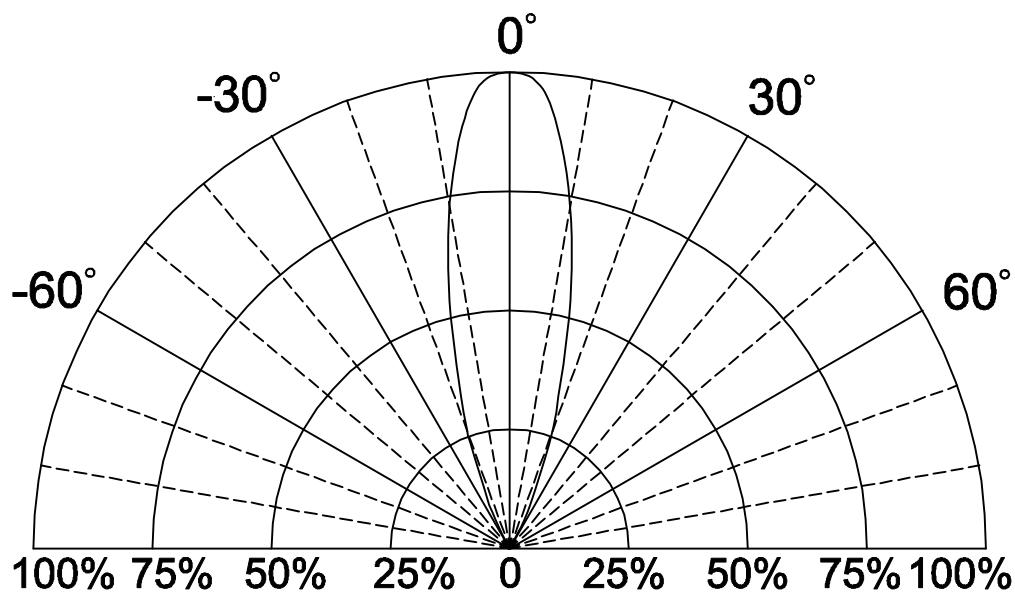
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Package Dimensions



Note : 1. All dimension are in millimeter tolerance is $\pm 0.25\text{mm}$ unless otherwise noted.
2. Specifications are subject to change without notice.

Directivity Radiation





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Absolute Maximum Ratings at Ta=25 °C

| Parameter | Symbol | Ratings | | UNIT |
|---|------------------|-----------|--|-------------|
| | | WK | | |
| Forward Current | I _F | 30 | | mA |
| Peak Forward Current Duty 1/10@10KHz | I _{FP} | 100 | | mA |
| Power Dissipation | P _D | 120 | | mW |
| Reverse Current @5V | I _r | 50 | | μA |
| Electrostatic Discharge(*) | ESD | 8000 | | V |
| Operating Temperature | T _{opr} | -20~ +80 | | °C |
| Storage Temperature | T _{stg} | -30~ +100 | | °C |

* Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handing these LED. All devices, equipment and machinery must be properly grounded.

Typical Electrical & Optical Characteristics (Ta=25 °C)

| PART NO | MATERIAL | COLOR | | Chromaticity Coordinates (Typ.) | | Forward voltage @20mA(V) | | Luminous intensity @20mA(mcd) | | Viewing angle 2θ 1/2 (deg) |
|---------------|-----------|---------|-------------|---------------------------------|------|--------------------------|------|-------------------------------|------|----------------------------|
| | | Emitted | Lens | X | Y | Typ. | Max. | Min. | Typ. | |
| LWK2043Z/F139 | InGaN/GaN | White | Water Clear | 0.28 | 0.28 | 3.5 | 4.0 | 1800 | 3000 | 30 |

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.
 2. The luminous intensity data did not including ±15% testing tolerance.



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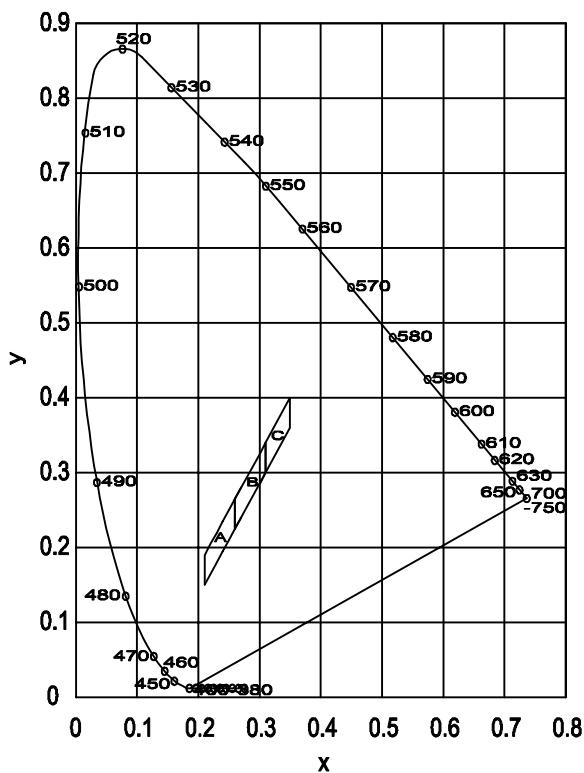
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. Chromaticity Coordinates Specifications for Bin Grading

| BIN | X | Y | BIN | X | Y | BIN | X | Y |
|-----|------|-------|-----|------|-------|-----|------|-------|
| A1 | 0.21 | 0.190 | B1 | 0.26 | 0.265 | C1 | 0.31 | 0.340 |
| | 0.21 | 0.150 | | 0.26 | 0.225 | | 0.31 | 0.300 |
| | 0.22 | 0.165 | | 0.27 | 0.240 | | 0.32 | 0.315 |
| | 0.22 | 0.205 | | 0.27 | 0.280 | | 0.32 | 0.355 |
| A2 | 0.22 | 0.205 | B2 | 0.27 | 0.280 | C2 | 0.32 | 0.355 |
| | 0.22 | 0.165 | | 0.27 | 0.240 | | 0.32 | 0.315 |
| | 0.23 | 0.180 | | 0.28 | 0.255 | | 0.33 | 0.330 |
| | 0.23 | 0.220 | | 0.28 | 0.295 | | 0.33 | 0.370 |
| A3 | 0.23 | 0.220 | B3 | 0.28 | 0.295 | C3 | 0.33 | 0.370 |
| | 0.23 | 0.180 | | 0.28 | 0.255 | | 0.33 | 0.330 |
| | 0.24 | 0.195 | | 0.29 | 0.270 | | 0.34 | 0.345 |
| | 0.24 | 0.235 | | 0.29 | 0.310 | | 0.34 | 0.385 |
| A4 | 0.24 | 0.235 | B4 | 0.29 | 0.310 | C4 | 0.34 | 0.385 |
| | 0.24 | 0.195 | | 0.29 | 0.270 | | 0.34 | 0.345 |
| | 0.25 | 0.210 | | 0.30 | 0.285 | | 0.35 | 0.360 |
| | 0.25 | 0.250 | | 0.30 | 0.325 | | 0.35 | 0.400 |
| A5 | 0.25 | 0.250 | B5 | 0.30 | 0.325 | | | |
| | 0.25 | 0.210 | | 0.30 | 0.285 | | | |
| | 0.26 | 0.225 | | 0.31 | 0.300 | | | |
| | 0.26 | 0.265 | | 0.31 | 0.340 | | | |

. CIE Chromaticity Diagram





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Typical Electro-Optical Characteristics Curve

WK CHIP

Fig.1 Forward current vs. Forward Voltage

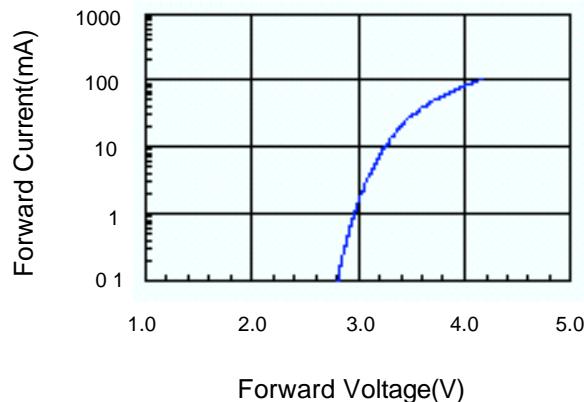


Fig.2 Relative Intensity vs. Forward Current

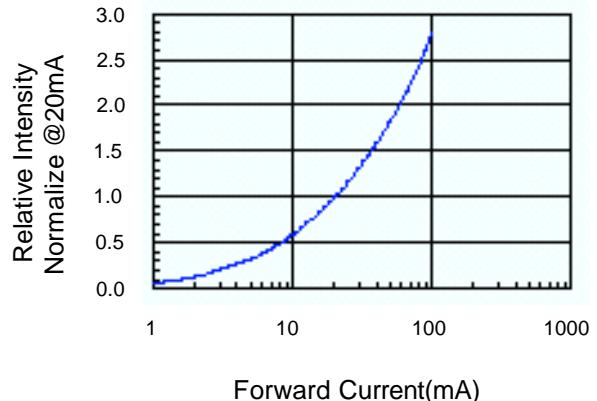


Fig.3 Forward Voltage vs. Temperature

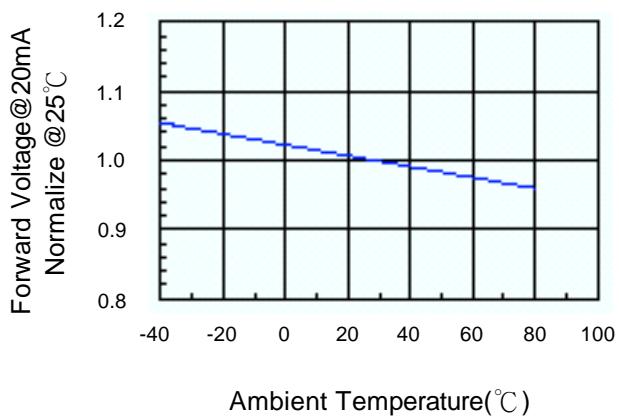


Fig.4 Relative Intensity vs. Temperature

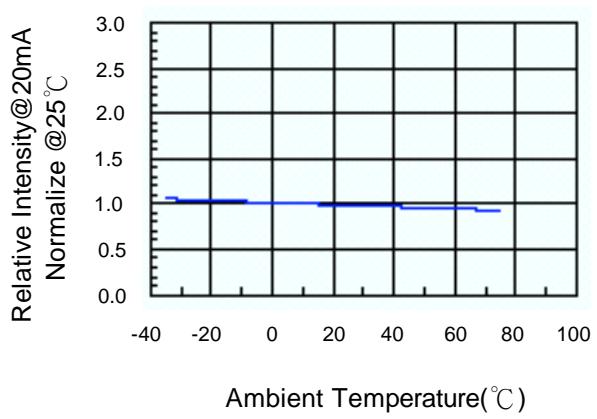
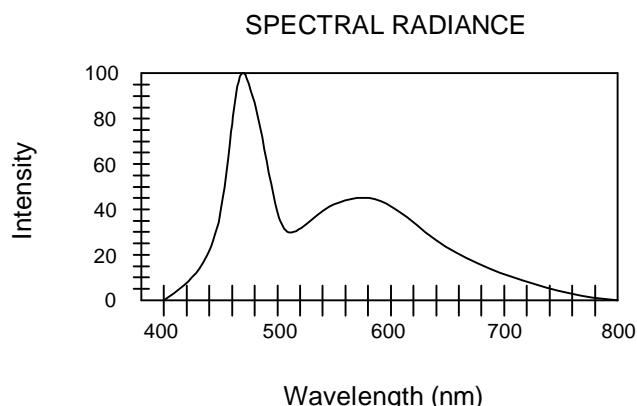


Fig.5 Luminous Spectrum($T_a=25^{\circ}\text{C}$)





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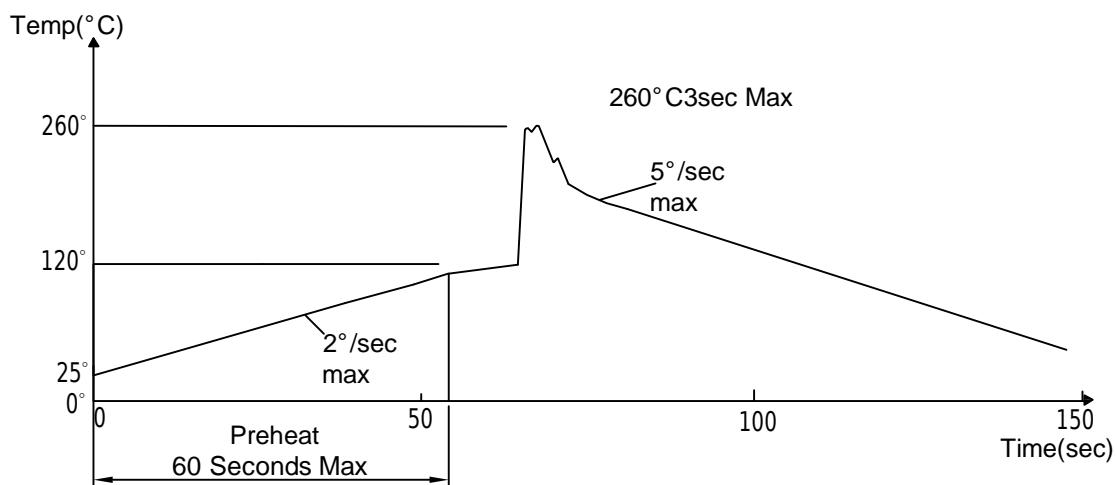
Soldering Condition(Pb-Free)

1.Iron:

Soldering Iron:30W Max
Temperature 350°C Max
Soldering Time:3 Seconds Max(One time only)
Distance:2mm Min(From solder joint to body)

2.Wave Soldering Profile

Dip Soldering
Preheat: 120°C Max
Preheat time: 60seconds Max
Ramp-up
2°C/sec(max)
Ramp-Down:-5°C/sec(max)
Solder Bath:260°C Max
Dipping Time:3 seconds Max
Distance:2mm Min(From solder joint to body)



Note: 1.Wave solder should not be made more than one time.
2.You can just only select one of the soldering conditions as above.



Reliability Test:

| Test Item | Test Condition | Description | Reference Standard |
|-------------------------------------|--|---|--|
| Operating Life Test | 1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs) | This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed. | MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1 |
| High Temperature Storage Test | 1.Ta=105 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of high temperature for hours. | MIL-STD-883:1008 JIS C 7021: B-10 |
| Low Temperature Storage Test | 1.Ta=-40 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of low temperature for hours. | JIS C 7021: B-12 |
| High Temperature High Humidity Test | 1.Ta=65 °C±5°C 2.RH=90%~95% 3.t=240hrs ±2hrs | The purpose of this test is the resistance of the device under tropical for hours. | MIL-STD-202:103B JIS C 7021: B-11 |
| Thermal Shock Test | 1.Ta=105 °C±5°C &-40°C±5°C (10min) (10min) 2.total 10 cycles | The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature. | MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011 |
| Solder Resistance Test | 1.T.Sol=260 °C±5°C 2.Dwell time= 10±1sec. | This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire. | MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1 |
| Solderability Test | 1.T.Sol=230 °C±5°C 2.Dwell time=5±1sec | This test intended to see soldering well performed or not. | MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2 |